ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	Il rights reserved untions.	nder both	This docume level parts, t	ent is a declar the declaratio	ration of n encon	of the substance mpasses all lo	es within wer leve	the manufact materials for	turer listed i which the n	tem. No nanufac	ote: if the turer has	e item is an as s engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mate					erials and M	rials and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Respon	Response Date*					
onsemi									2023-06-08						
Contact Name T			Title - Contact			Phone - Contact*					Email -	Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				Email -	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Requester Item Number	Requester Item Number Mfr Iter		n Number Mfr Item Name			Effective Da	ate V	ersion	Manufacturing Site			Weight	*	UOM	Unit Type
	FSA225	7L10X	Dual SPDT Analog Switch			2023-06-08		TH2			8.813692		mg	Each	
Aanufacturing Proccess Informa	ation													1	I
Terminal Plating / Grid Array M	Iaterial '	Terminal Base	Alloy	J-STD-020 MSL R		Peak Process		Body Temperature Max Time at Pea		ak Tempera	Temperature Numb		of Reflow Cyc	les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С	30	30		seconds 3			
omments															
evel 1 - maximum time at peak temperat	ture during so	ldering is 10-3	0 seconds												
or more information regarding materia	l composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.1186	mg	Supplier	Silicon (Si)	7440-21-3		2.1186	mg
Die Attach	0.016	mg	Supplier	Bis-phenol A Diglycidyl Ether	1675-54-3		0.0032	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0096	mg
			Supplier	2,4,6-Tris[Bis(Methoxymethyl)Amino]- 1,3,5-Triazine	3089-11-0		0.0032	mg
Mold Compound-Black	4.45	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.6675	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0222	mg
			Supplier	Silica (SiO2)	14464-46-1		3.7602	mg
Plating	0.02495	mg	В	Nickel (Ni)	7440-02-0		0.0205	mg
			Supplier	Gold (Au)	7440-57-5		0.0045	mg
Substrate	2.12415	mg	Supplier	Bismaleimide	13676-54-5		1.0461	mg
			Supplier	Cyanic acid (1-methylethylidene)di-4,1- phenylene ester homopolymer	25722-66-1		0.6797	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.054	mg
			В	Nickel (Ni)	7440-02-0		0.0212	mg
			Supplier	Gold (Au)	7440-57-5		0.0045	mg
			Supplier	Copper (Cu)	7440-50-8		0.3186	mg
Wire Bond - Au	0.079992	mg	Supplier	Gold (Au)	7440-57-5		0.08	mg